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REVISION HISTORY

6/2016—Rev. 0 to Rev. A

Changes to Figure 3 and Table 4	5
Updated Outline Dimensions	12
Changes to Ordering Guide	12

10/2005—Revision 0: Initial Version

SPECIFICATIONS

$T_A = 25^\circ\text{C}$, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, Belden cable, $V_{\text{OFFSET}} = 0\text{ V}$, V_{GAIN} and V_{PEAK} set to optimized settings (see Figure 4), unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Large Signal Bandwidth	V _{OUT} = 2 V p-p, 100 meter CAT-5		120		MHz
±1 dB Equalized Bandwidth Flatness	V _{OUT} = 2 V p-p		70		MHz
Rise/Fall Time	V _{OUT} = 2 V step, 50 meter CAT-5		2		ns
Rise/Fall Time	V _{OUT} = 2 V step, 100 meter CAT-5		3.6		ns
Settling Time to 2%	V _{OUT} = 2 V step, 50 meter CAT-5		26		ns
Settling Time to 2%	V _{OUT} = 2 V step, 100 meter CAT-5		36.4		ns
Integrated Output Voltage Noise	V _{PEAK} = 0.9 V, V _{GAIN} = 225 mV, BW = 1 GHz		1.5		mV rms
DC PERFORMANCE					
Input Bias Current			15.5	24	μA
V _{OFFSET} Pin Current			1.7	8.2	μA
V _{GAIN} Pin Current			2	3.4	μA
V _{PEAK} Pin Current			4.2	6.8	μA
INPUT CHARACTERISTICS					
Input Differential Voltage			±2.8		V
Input Common-Mode Voltage			±3.0		V
Input Resistance	Common mode		380		kΩ
	Differential		675		kΩ
Input Capacitance			1.7		pF
Common-Mode Rejection Ratio (CMRR)	200 kHz, ΔV _{OUT} /ΔV _{IN, cm}	–63	–74		dB
ADJUSTMENT PINS					
V _{PEAK} Input Voltage	Relative to ground	0		1	V
Maximum Peak Gain	At 120 MHz, V _{PEAK} = 1 V		20		dB
V _{GAIN} Input	Relative to ground	0		1	V
Maximum Broadband Gain	V _{GAIN} = 1 V		3		dB
V _{OFFSET} Input Range	Relative to ground		±2.5		V
V _{OFFSET} to V _{OUT} Gain			1		V/V
OUTPUT CHARACTERISTICS					
Output Voltage Swing		–2.55		+2.7	V
Output Offset Voltage	V _{OFFSET} = 0 V, RTO	–10.9	+7	+18.7	mV
Output Offset Voltage Drift			–5.5		μV/°C
Short-Circuit Output Current			100		mA
POWER SUPPLY					
Operating Voltage Range		±4.5		±5.5	V
Quiescent Supply Current, I _{CC} /I _{EE}	At ±5 V		+24/–21	+31/–27	mA
Supply Current Drift, I _{CC} /I _{EE}			+86/–77		μA/°C
+Power Supply Rejection Ratio (PSRR)	RTO	–48	–59		dB
–Power Supply Rejection Ratio (PSRR)	RTO	–48	–61		dB
TEMPERATURE RANGE					
		–40		+85	°C

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	$\pm 5.5\text{ V}$
Input Voltage	$\pm V_S$
V_{PEAK} and V_{GAIN} Control Pins	-3 V to $+V_S$
V_{OFFSET} Control Pins	$\pm V_S$
Operating Temperature Range	-40°C to $+85^\circ\text{C}$
Storage Temperature Range	-65°C to $+125^\circ\text{C}$
Lead Temperature (Soldering 10 sec)	300°C
Junction Temperature	150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
8-Lead LFCSP	77	14	$^\circ\text{C}/\text{W}$

Maximum Power Dissipation

The maximum safe power dissipation in the AD8128 package is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C , which is the glass transition temperature, the plastic changes the properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the AD8128. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for the output. The quiescent power is the voltage between the supply pins (V_S) times the quiescent current (I_S). The power dissipated due to the load drive depends upon the particular application. For each output, the power due to load drive is calculated by multiplying the load current by the associated voltage drop across the

Airflow increases heat dissipation, effectively reducing θ_{JA} . Also, more metal directly in contact with the package leads from metal traces, through-holes, ground, and power planes reduces the θ_{JA} . The exposed pad on the underside of the package must be soldered to a pad on the PCB surface, which is thermally connected to a copper plane to achieve the specified θ_{JA} .

Figure 2 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 8-lead LFCSP ($48.5^\circ\text{C}/\text{W}$) on a JEDEC standard 4-layer board with the underside pad soldered to a pad that is thermally connected to a PCB plane. Extra thermal relief is required for operation at high supply voltages.

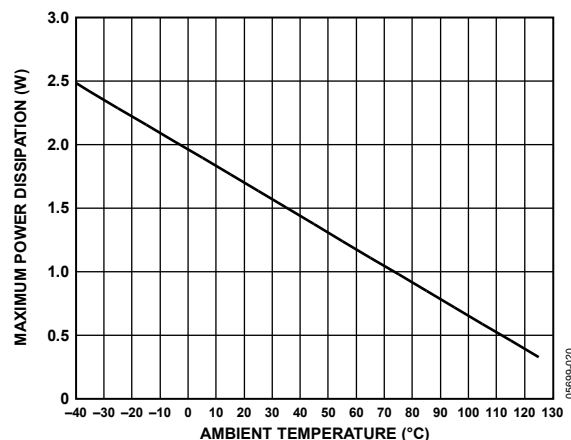


Figure 2. Maximum Power Dissipation vs. Temperature

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

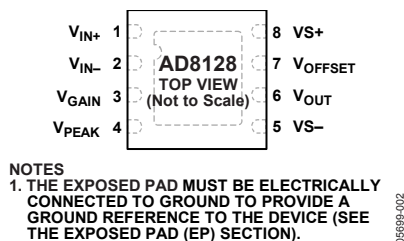


Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V _{IN+}	Positive Equalizer Input
2	V _{IN-}	Negative Equalizer Input
3	V _{GAIN}	0 V to 1 V Broadband Gain Control
4	V _{PEAK}	0 V to 1 V High Frequency Gain Control
5	V _{S-}	Negative Power Supply
6	V _{OUT}	Equalizer Output
7	V _{OFFSET}	DC Offset Adjust
8	V _{S+}	Positive Power Supply
EP	GND	Ground Reference and Thermal Pad. The exposed pad must be electrically connected to ground to provide a ground reference to the device (see the Exposed Pad (EP) section).

TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$, $V_S = \pm 5\text{ V}$, $R_L = 150\ \Omega$, Belden cable, $V_{\text{OFFSET}} = 0\text{ V}$, unless otherwise noted.

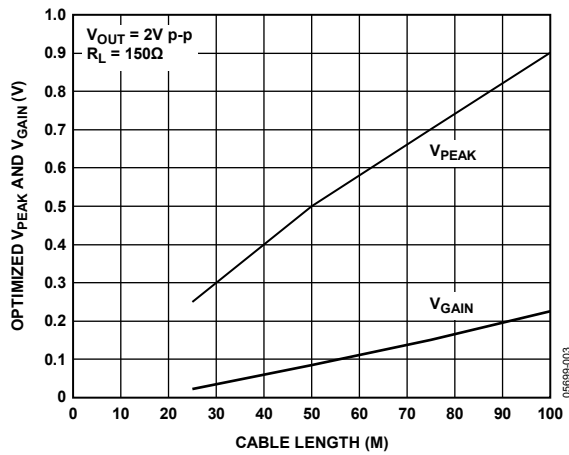


Figure 4. V_{PEAK} and V_{GAIN} Settings vs. Cable Length

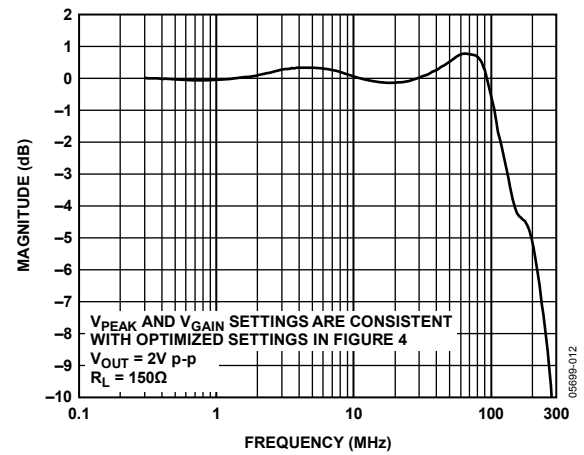


Figure 7. Equalized Frequency Response for 50 M Cable

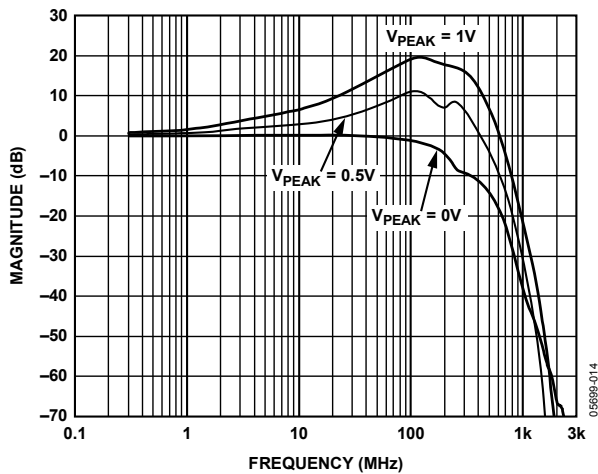


Figure 5. Frequency Response for Various V_{PEAK} Settings Without Cable

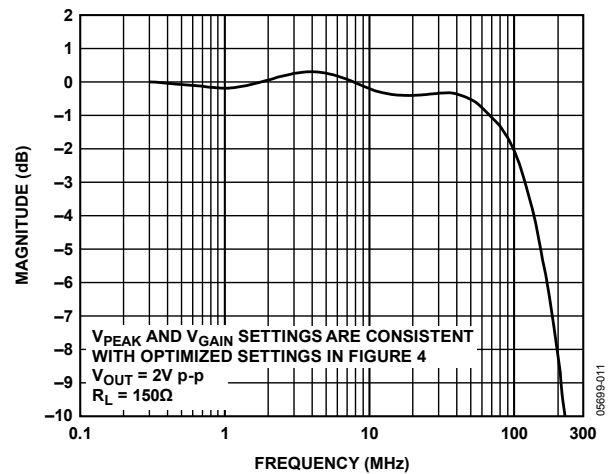


Figure 8. Equalized Frequency Response for 100 M Cable

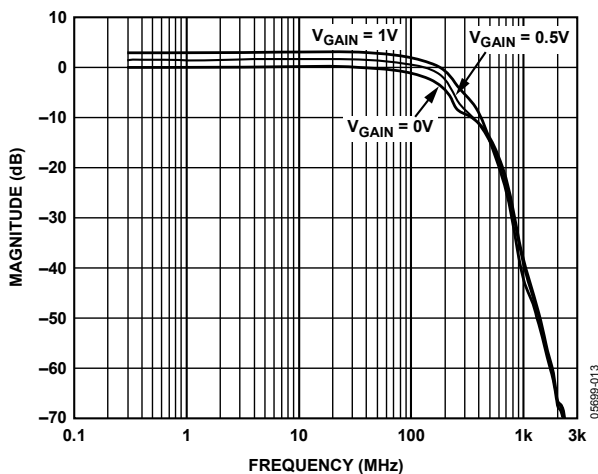


Figure 6. Frequency Response for Various V_{GAIN} Settings Without Cable

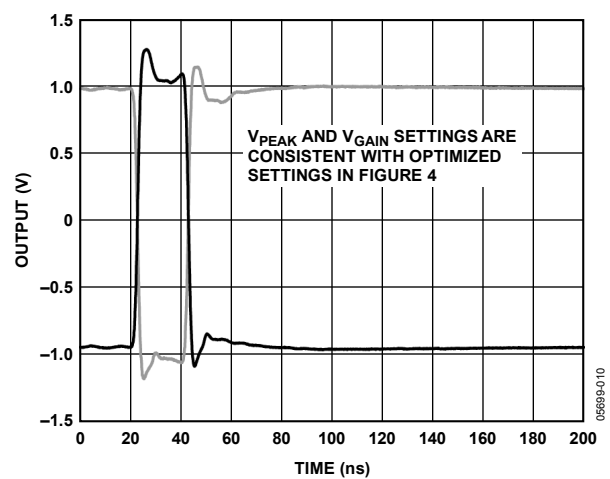


Figure 9. Equalized Pulse Response for 50 M of Cable

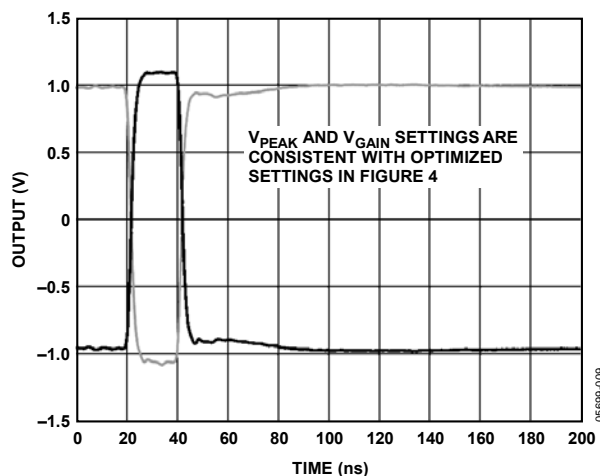


Figure 10. Equalized Pulse Response for 100 M of Cable

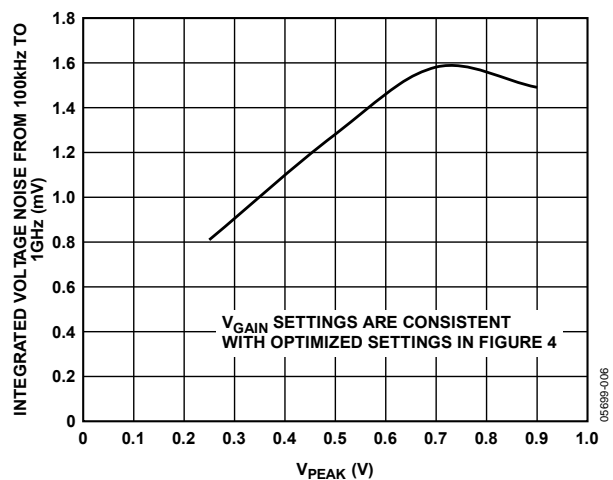
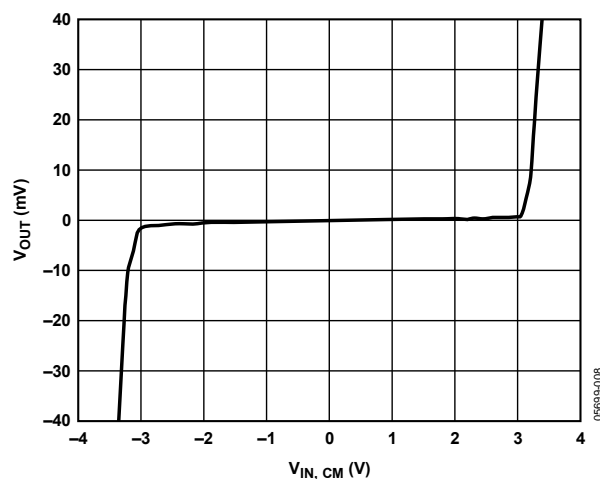
Figure 13. Integrated Voltage Noise vs. V_{PEAK} 

Figure 11. Output Voltage vs. Common-Mode Input Voltage

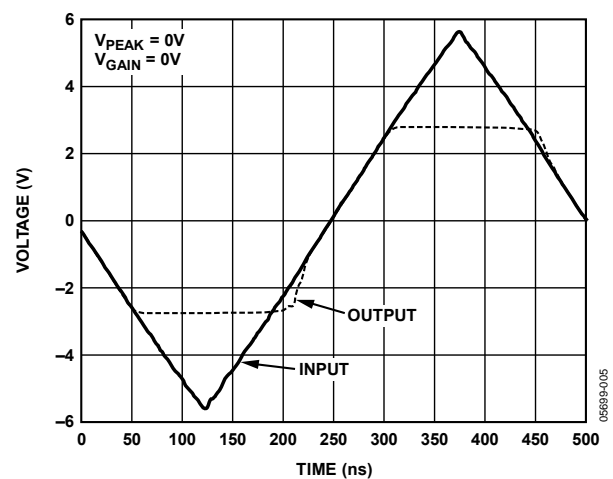


Figure 14. Overdrive Recovery Time

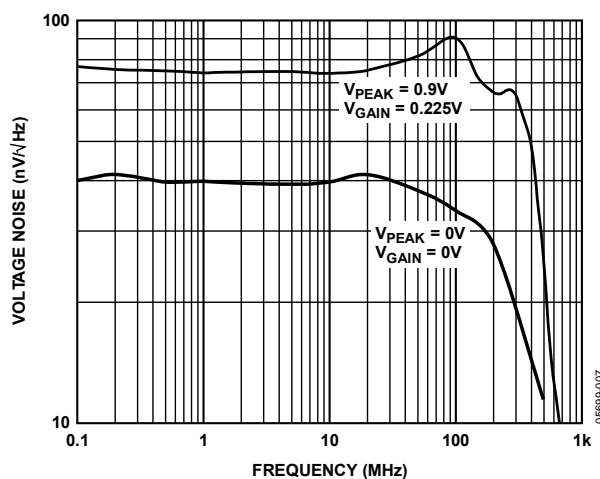


Figure 12. Voltage Noise vs. Frequency

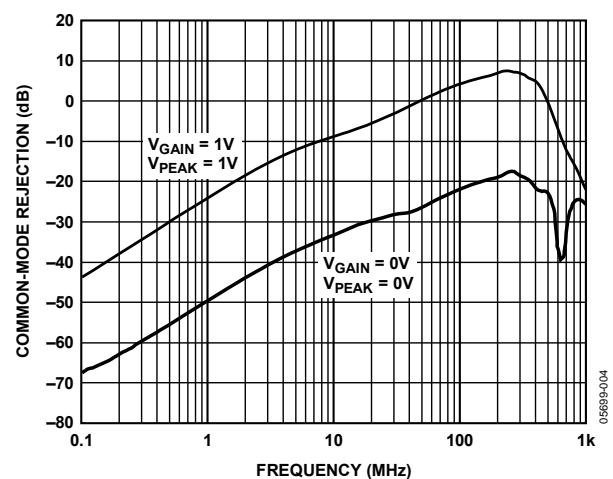


Figure 15. Common-Mode Rejection vs. Frequency

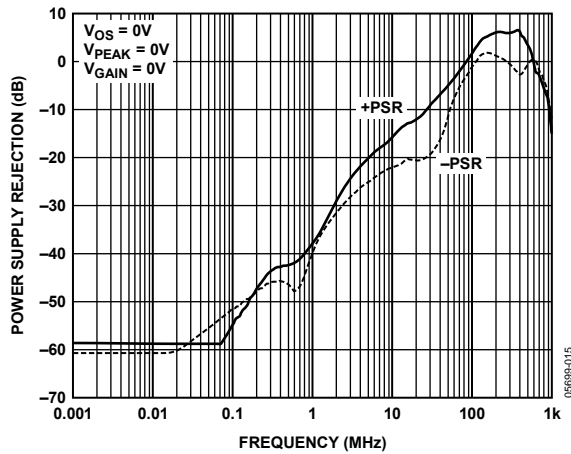


Figure 16. Power Supply Rejection vs. Frequency

TEST CIRCUIT

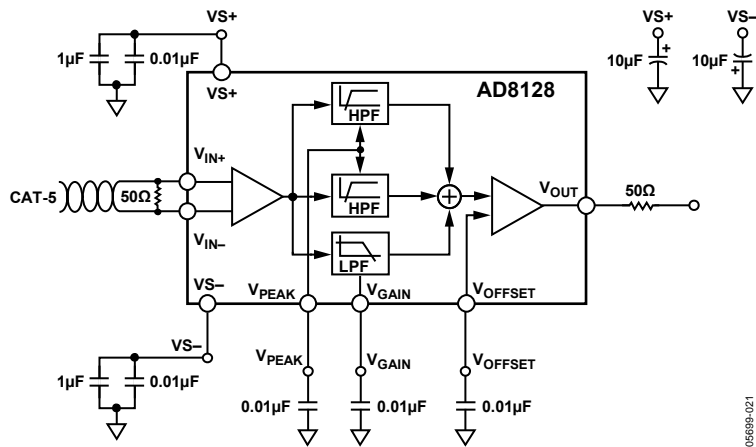


Figure 17.

THEORY OF OPERATION

The **AD8128** is a high speed, low noise analog line equalizer that compensates for losses in CAT-5/CAT-5e cables up to 100 meters with ± 1 dB flatness in the pass band out to 70 MHz (see Figure 8). Two continuously adjustable control voltages alter the frequency response to add flexibility to the system by allowing for the compensation of various cable lengths as well as for variations in the cable itself. The dc control voltage pin V_{GAIN} adjusts ac broadband gain from 0 dB to 3 dB (see Figure 6) to account for dc resistive losses present in the cable. A second dc control voltage pin V_{PEAK} adjusts the amount of high frequency peaking (see Figure 5) from 0 dB to 20 dB. This compensates for the high frequency loss due to the skin effect of the cable.

The **AD8128** has a high impedance differential input that allows it to receive dc-coupled signals directly from the cable. For systems with very high CMRR specifications, the **AD8128** can also be used with a dedicated receiver, such as the **AD8130** or **AD8143**, placed in front of it. The output of the **AD8128** is low impedance and is capable of driving a 150 Ω load resistor and up to 20 pF of load capacitance at the output. For systems with high parasitic capacitances at the output, it is recommended that a small series resistor be placed between the output and capacitive load to reduce ringing in the pulse response.

The **AD8128** is designed to be used in medium-length systems that have stringent low noise requirements as well as longer-length systems that can tolerate more noise. For the medium-length requirements, a single **AD8128** is able to compensate up to 100 meters of cable with only 1.5 mV rms of output noise. For longer-length applications that require equalization of up to 200 meters of cable, two **AD8128** devices can be cascaded together to achieve the desired equalization, while keeping approximately the same pass-band bandwidth, but with a slight degradation in settling time and slew rate.

The frequency response of the **AD8128** approximates the inverse frequency response of a lossy transmission line, which is given by

$$H(f) = e^{kl(1+j)\sqrt{f}} \quad (1)$$

where:

f is the frequency.

l is the length.

k is the line constant.

The **AD8128** approximates the magnitude response of Equation 1 by summing multiple zero-poles pairs offset at different frequencies. Equalization adjustment due to varying line lengths is done by changing the weighting factors of each of the zero-pole pairs.

INPUT COMMON-MODE VOLTAGE RANGE CONSIDERATIONS

When using the **AD8128** as a receiver, it is important to ensure that the input common-mode (CM) voltage range of the **AD8128** stays within the specified range. The input CM level can be easily calculated by adding the CM level of the driver, the amplitude of any sync pulses, and the other possible induced common-mode signals from power lines and fluorescent lights.

$$V_{\text{ICM}} = V_{\text{CM}} + V_{\text{SYNC}} + V_{\text{OTHER}} \quad (2)$$

For example, when using a single 5 V supply on the drive side, the CM voltage of the line typically becomes the midsupply voltage, $V_{\text{CM}} = 2.5$ V. Furthermore, an addition of a sync signal, $V_{\text{SYNC}} = 0.5$ V, on to the common mode puts the peak CM voltage at 3 V. Assuming that both the driver and receiver have exactly the same ground potential, the signal is marginally below the upper end of the common-mode input range of 3.1 V. Other CM signals that can be picked up by the CAT-5 cable result in exceeding the CM input range of the **AD8128**.

The most effective way of not exceeding the CM level of the **AD8128** is to lower the CM level on the driver. In the previous example, this was the primary contributor to the CM input level. If this is not possible, a dedicated receiver with a wider CM input range, such as the **AD8130** or **AD8143**, must be used.

APPLICATIONS INFORMATION

KVM APPLICATIONS

In KVM applications, cable equalization typically occurs at the root of the KVM network. In a star configuration, a driver is located at each of the end nodes and a receiver/equalizer is located at the single root node. In a daisy-chain configuration, each of the end nodes are connected to one another, and one of them is connected to the root. Similarly, the drivers are placed on the nodes, and the receivers/equalizers are placed at the root.

In both of these aforementioned configurations, three AD8128 receiver/equalizers can be used at the root node to equalize the transmitted red (R), green (G), and blue (B) channels for up to 100 meters of cable. Since the skew between two pairs of cables in CAT-5 is less than 1%, the control pins can be tied together and used as a single set of controls.

If the common-mode levels of the inputs permit using the AD8128 as a receiver (see the Input Common-Mode Voltage Range Considerations section), the input signal must be terminated by a 100 Ω shunt resistor between the pairs, or by two 50 Ω shunt resistors with a common-mode tap in the middle. This CM tap can extract the sync information from the signal if sync-on-common-mode is used.

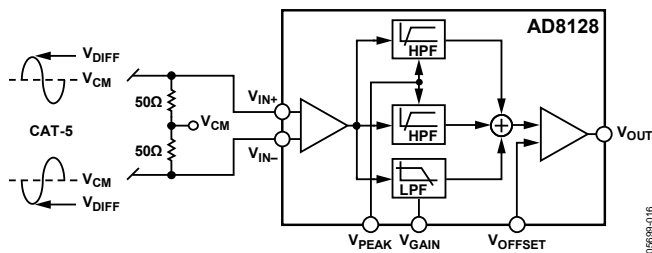


Figure 18. Single Receiver Configuration for CAT-5 Equalizer

DC CONTROL PINS

The AD8128 uses two control pins (V_{GAIN} and V_{PEAK}) to adjust the equalization based on the length of the cable and one pin (V_{OFFSET}) to adjust the dc output offset. V_{GAIN} is a user-adjustable 0 V to 1 V broadband gain control pin, and V_{PEAK} is a 0 V to 1 V adjustable high frequency gain pin to equalize for the skin effect in CAT-5 cable. The values of both V_{PEAK} and V_{GAIN} are linearly correlated to the length of the cable to be equalized. A simple formula can approximate the desired values for both of these pins.

$$V_{GAIN} = \frac{\text{length}(m)}{425m/V} \quad (3)$$

$$V_{PEAK} = \frac{\text{length}(m)}{110m/V} \quad (4)$$

While these equations give a close approximation of the desired value for each pin, to achieve optimal performance, it can be necessary to adjust these values slightly.

Figure 19 and Figure 20 illustrate circuits that adjust the control pins on the AD8128. In Figure 19, a 1 k Ω potentiometer adjusts the control pin voltage between the specified range of 0 V to 1 V. In Figure 20, a 2 k Ω potentiometer controls the offset pin from -2.5 V to +2.5 V. For both of these configurations, a ± 5 V supply is assumed.

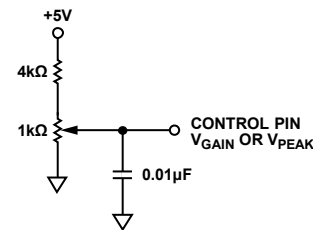


Figure 19. Circuit to Control V_{GAIN} and V_{PEAK} (0 V to 1 V)

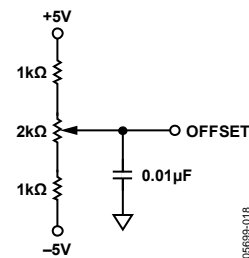


Figure 20. Circuit to Control V_{OFFSET} (± 2.5 V)

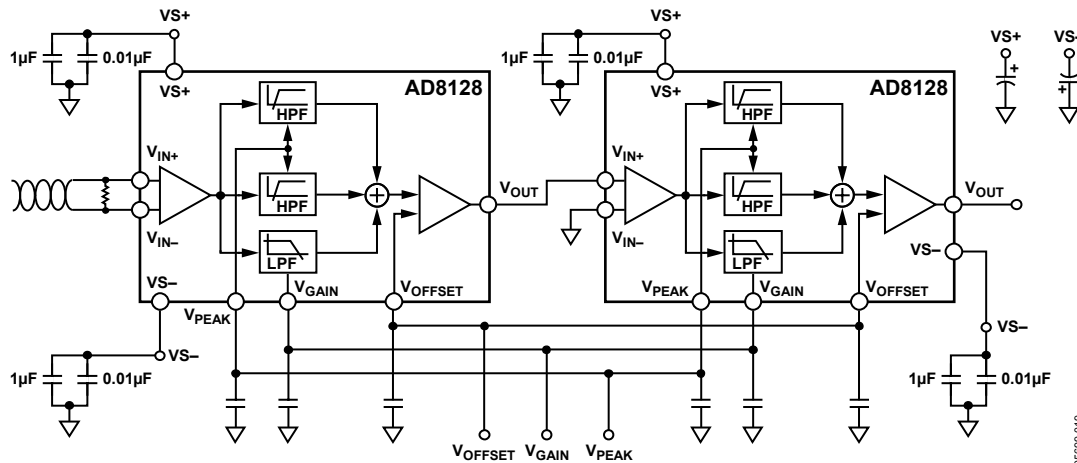


Figure 21. Cascaded AD8128 Configuration

CASCADED APPLICATIONS

To equalize distances longer than the specified 100 meters, the AD8128 can be cascaded to provide equalization for longer distances. When combining two AD8128 devices in series, it is possible to link the control pins together and use them like a single control pin for up to 200 meters of equalization.

In this configuration, it is important to note that some key video specifications can be slightly degraded. By combining two equalizers in series, specifications such as rise time and settling time both increase while 3 dB bandwidth decreases slightly. Also, integrated noise is increased because the second equalizer adds gain. Subjective testing must be done to determine the appropriate setting for the three control pins for optimum equalization.

EXPOSED PAD (EP)

The 8-lead LFCSP has an exposed pad on the underside of the body. To achieve the specified thermal resistance, it must have a good thermal connection to one of the PCB planes. The exposed pad must be soldered to a pad on top of the board connected to an inner plane with several thermal vias. For the AD8128, this pad must also be electrically connected to ground to provide a ground reference to the device.

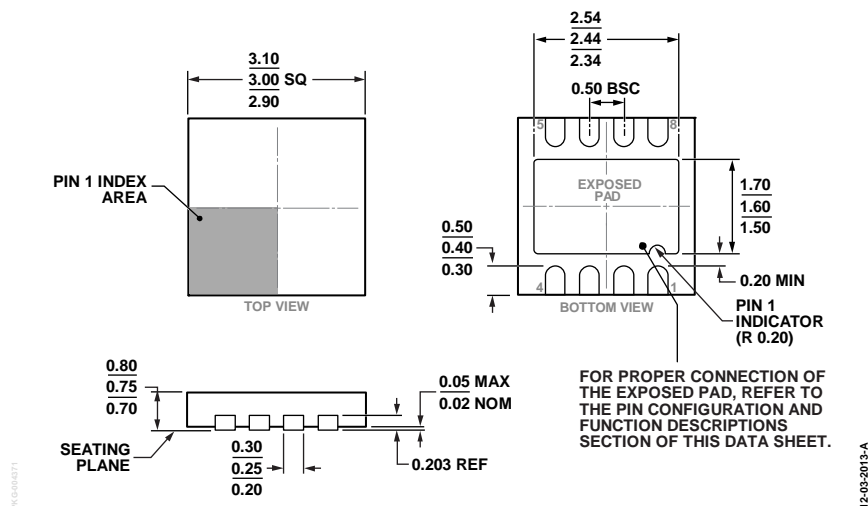
LAYOUT AND POWER SUPPLY DECOUPLING CONSIDERATIONS

Standard high speed PCB layout practices must be adhered to when designing with the AD8128. A solid ground plane is recommended and good wideband power supply decoupling networks must be placed as close as possible to the supply pins and control pins. Small surface-mount ceramic capacitors are recommended for these networks, and tantalum capacitors are recommended for bulk supply decoupling.

EVALUATION BOARDS

There are two evaluation boards available for easy characterization of the AD8128. A general-purpose evaluation board consisting of a single AD8128, with an option of also using a dedicated receiver, is available for simple characterization of the device. Additionally, a KVM application specific evaluation board is available. This evaluation board consists of six AD8128 devices to equalize each of the RGB channels up to 200 meters, a 16-pin 26C32 comparator for sync-on-common-mode extract and a triple op amp to provide additional gain if necessary.

OUTLINE DIMENSIONS



ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Branding
AD8128ACPZ-R2	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-21	HZB
AD8128ACPZ-RL	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-21	HZB
AD8128ACPZ-R7	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-21	HZB

¹ Z = RoHS Compliant Part.